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FDS5680

60V N-Channel PowerTrench™ MOSFET

General Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench process that has been especially tailored to minimize on-state resistance and yet maintain superior switching performance.

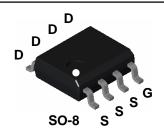
These devices are well suited for low voltage and battery powered applications where low in-line power loss and fast switching are required.

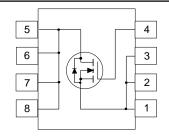
Applications

- DC/DC converter
- · Load switch
- Motor drives

Features

- 8 A, 60 V. $R_{DS(ON)} = 0.020 \ \Omega \ @V_{GS} = 10 \ V$ $R_{DS(ON)} = 0.025 \ \Omega \ @V_{GS} = 6 \ V.$
- Low gate charge (30nC typical).
- · Fast switching speed.
- \bullet High performance trench technology for extremely low $R_{_{DS_i(ON)}}.$
- · High power and current handling capability.





Absolute Maximum Ratings T_A = 25°C unless otherwise noted

Symbol	Parameter		Ratings	Units	
V _{DSS}	Drain-Source Voltage		60	V	
V _{GSS}	Gate-Source Voltage		±20	V	
I _D	Drain Current - Continuous	(Note 1a)	8	A	
	- Pulsed		50		
P _D	Power Dissipation for Single Operation	(Note 1a)	2.5	W	
		(Note 1b)	1.2		
		(Note 1c)	1		
T _J , T _{stg}	Operating and Storage Junction Temperature Range		-55 to +150	°C	

Thermal Characteristics

R _e JA	Thermal Resistance, Junction-to-Ambient	(Note 1a)	50	°C/W
R _e JC	Thermal Resistance, Junction-to-Case	(Note 1)	25	°C/W

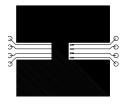
Package Outlines and Ordering Information

Device Marking	Device	Reel Size	Tape Width	Quantity	
FDS5680 FDS5680		13"	12mm	2500 units	

©1999 Fairchild Semiconductor Corporation FDS5680 Rev. C

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Char	acteristics					
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	60			V
ΔBV _{DSS} ΔT _J	Breakdown Voltage Temperature Coefficient	I_D = 250 μ A, Referenced to 25°C		27		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 48 V, V _{GS} = 0 V			1	μΑ
I _{GSSF}	Gate-Body Leakage Current, Forward	V _{GS} = 20 V, V _{DS} = 0 V			100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	V _{GS} = -20 V, V _{DS} = 0 V			-100	nA
On Char	acteristics (Note 2)					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu\text{A}$	2	2.5	4	V
$\Delta V_{GS(th)} \ \Delta T_J$	Gate Threshold Voltage Temperature Coefficient	I_D = 250 μ A, Referenced to 25°C		-4.5		mV/°C
R _{DS(on)}	Static Drain-Source On-Resistance	$V_{GS} = 10 \text{ V, } I_D = 8 \text{ A} \\ V_{GS} = 10 \text{ V, } I_D = 8 \text{ A, } T_J = 125^{\circ}\text{C} \\ V_{GS} = 6 \text{ V, } I_D = 7.5 \text{ A} \\$		0.017 0.027 0.019	0.020 0.032 0.025	Ω
I _{D(on)}	On-State Drain Current	V _{GS} = 10 V, V _{DS} = 5 V	25			Α
g FS	Forward Transconductance	$V_{DS} = 5 \text{ V}, I_{D} = 8 \text{ A}$		28		mS
Dynamic	: Characteristics					
C _{iss}	Input Capacitance	V _{DS} = 15 V, V _{GS} = 0 V		1850		pF
Coss	Output Capacitance	f = 1.0 MHz		290		pF
C _{rss}	Reverse Transfer Capacitance			100		pF
Switchin	g Characteristics (Note 2)					
t _{d(on)}	Turn-On Delay Time	$V_{DD} = 30 \text{ V}, I_{D} = 1 \text{ A}$		13	24	ns
t _r	Turn-On Rise Time	$V_{GS} = 10 \text{ V}, R_{GEN} = 6 \Omega$		8	16	ns
t _{d(off)}	Turn-Off Delay Time			16	26	ns
t _f	Turn-Off Fall Time			32	50	ns
Qg	Total Gate Charge	V _{DS} = 15 V, I _D = 8 A		30	42	nC
Q _{gs}	Gate-Source Charge	V _{GS} = 10 V,		8.5		nC
Q _{gd}	Gate-Drain Charge			5.5		nC
Drain-So	ource Diode Characteristics an	d Maximum Ratings				
Is	Maximum Continuous Drain-Sou				2.1	Α
V _{SD}	Drain-Source Diode Forward Voltage	V _{GS} = 0 V, I _S = 2.1 A (Note 2)		0.74	1.2	V

^{1:} R_{0JA} is the sum of the junction-to-case and case-to-ambient resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. $R_{\theta JC}$ is guaranteed by design while $R_{\theta CA}$ is determined by the user's board design.







Scale 1 : 1 on letter size paper

2: Pulse Test: Pulse Width $\leq\!300~\mu\text{s}$, Duty Cycle $\leq\!2.0\%$

Typical Characteristics

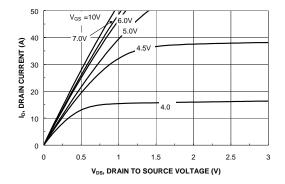


Figure 1. On-Region Characteristics.

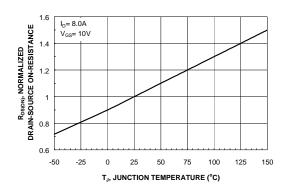


Figure 3. On-Resistance Variation with Temperature.

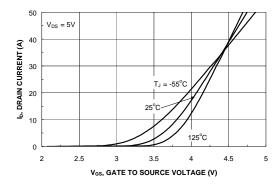


Figure 5. Transfer Characteristics.

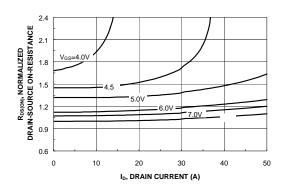


Figure 2. On-Resistance Variation with Drain Current and Gate Voltage.

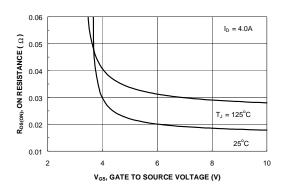


Figure 4. On-Resistance Variation with Gate-to-Source Voltage.

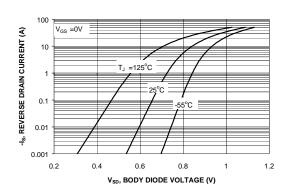
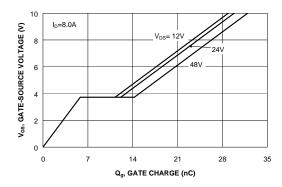


Figure 6. Body Diode Forward Voltage Variation with Source Current and Temperature.

Typical Characteristics (continued)



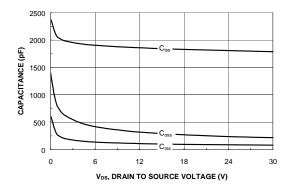
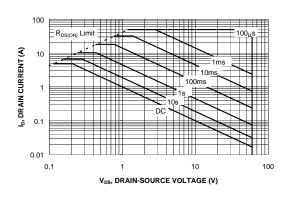


Figure 7. Gate Charge Characteristics.





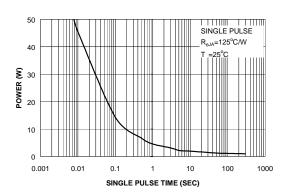


Figure 9. Maximum Safe Operating Area.

Figure 10. Single Pulse Maximum Power Dissipation.

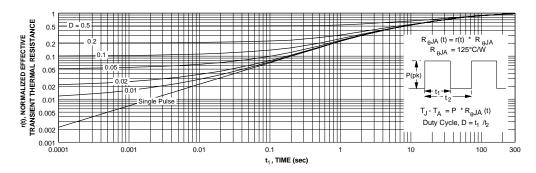


Figure 11. Transient Thermal Response Curve.

Thermal characterization performed using the conditions described in Note 1c. Transient themal response will change depending on the circuit board design.

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